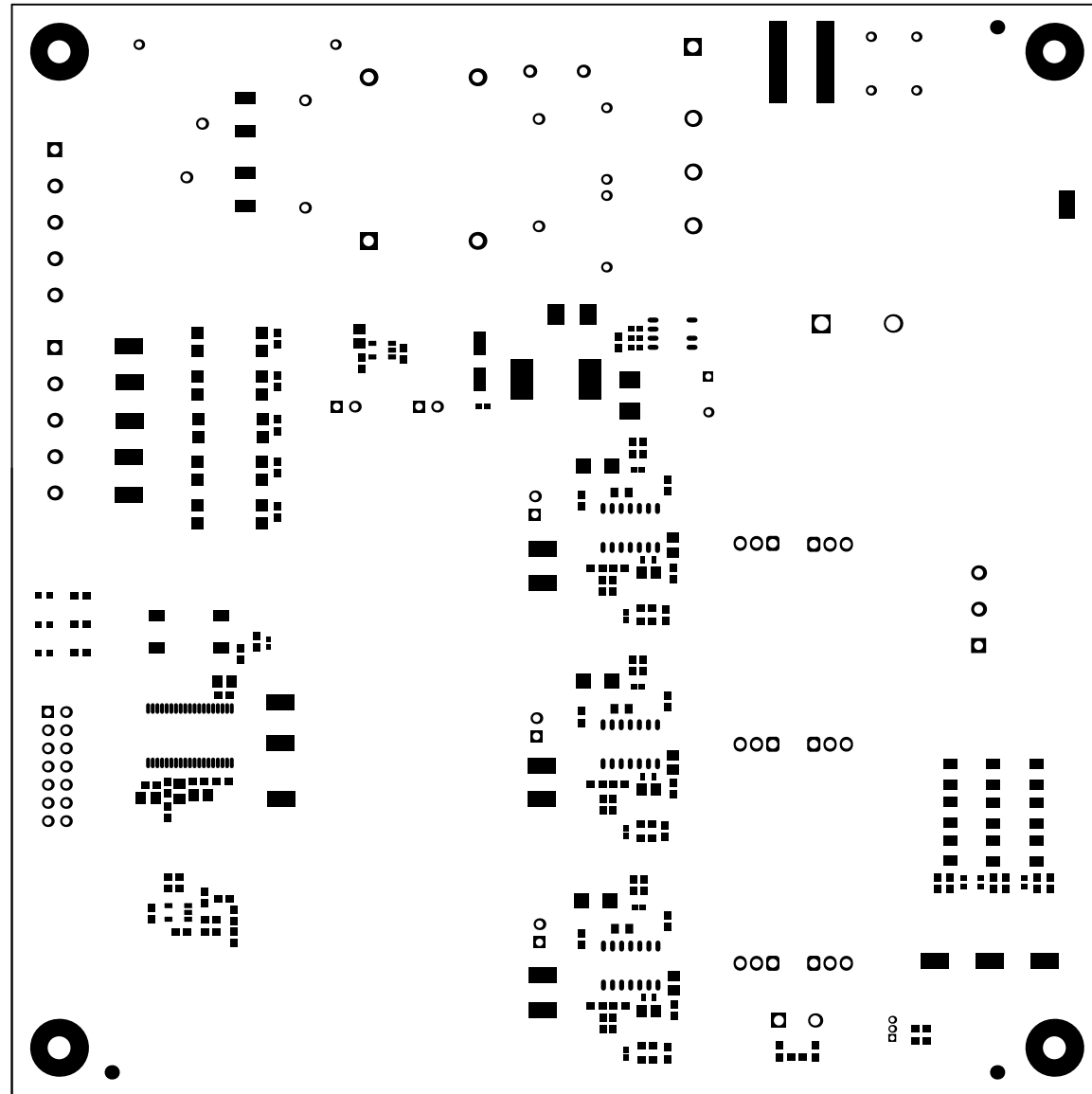
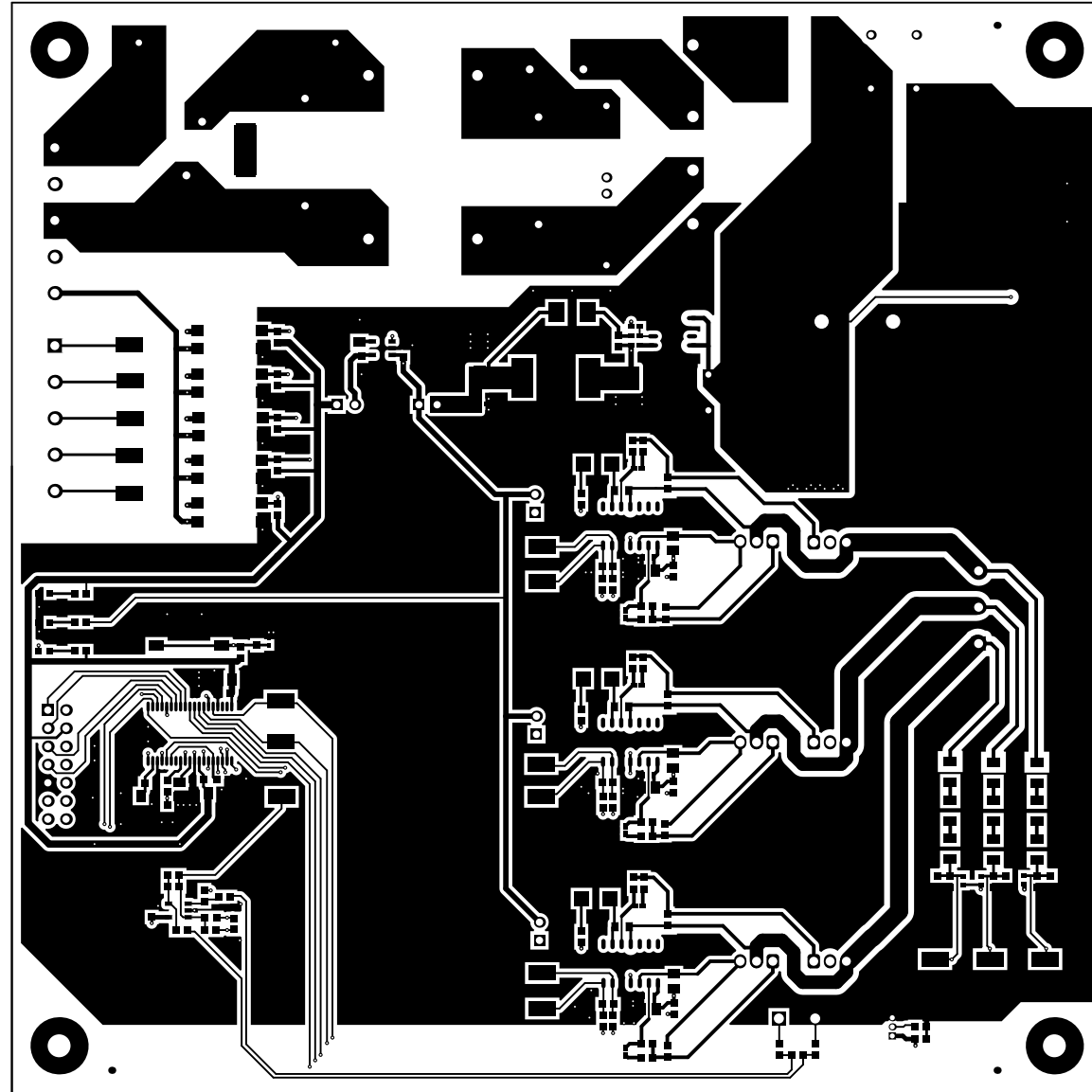


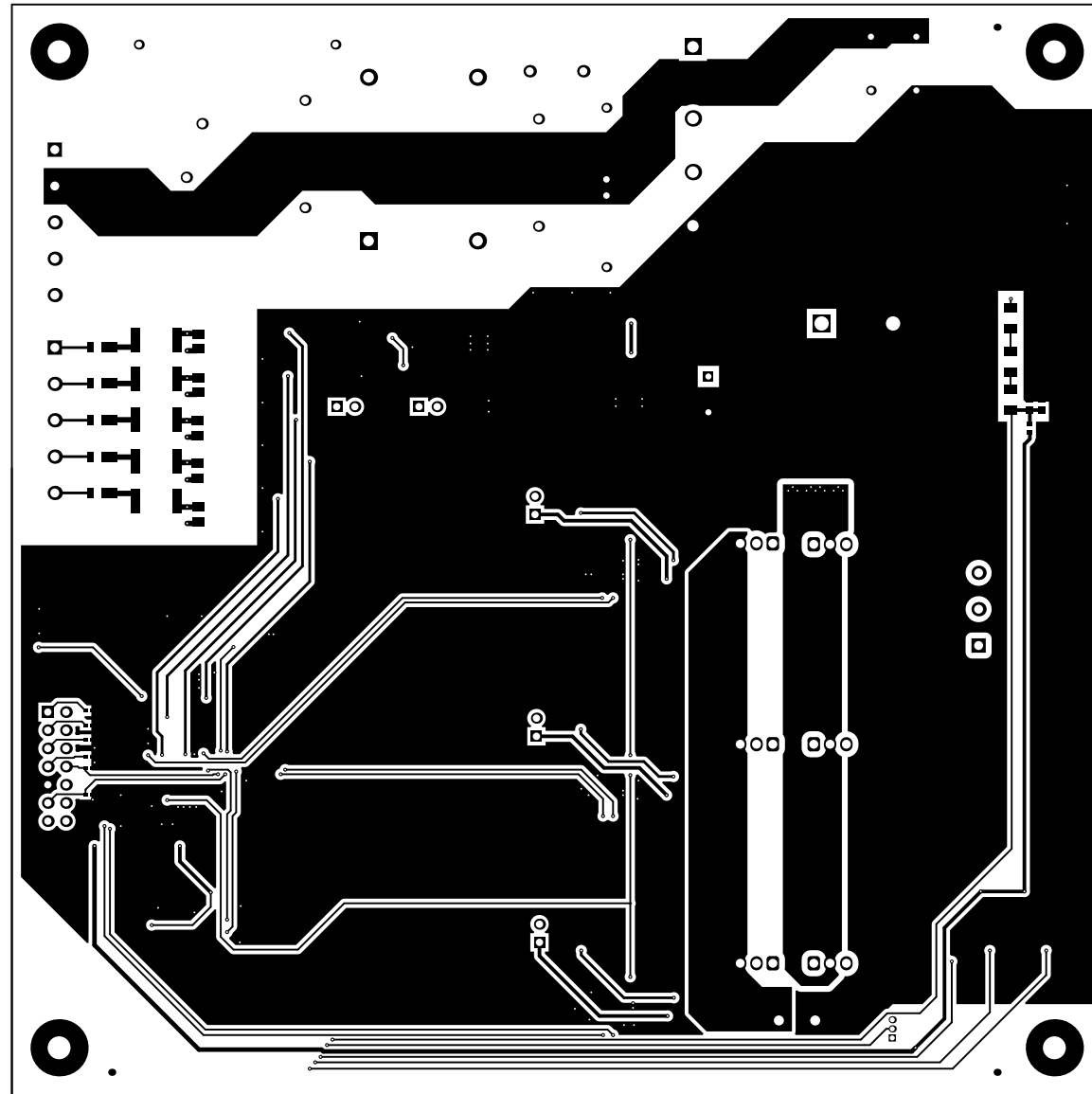
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01353	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay	TID #: TIDA-01353		
PLOT NAME = Top Overlay	GENERATED : 11/11/2016 2:58:22 PM	TEXAS INSTRUMENTS	



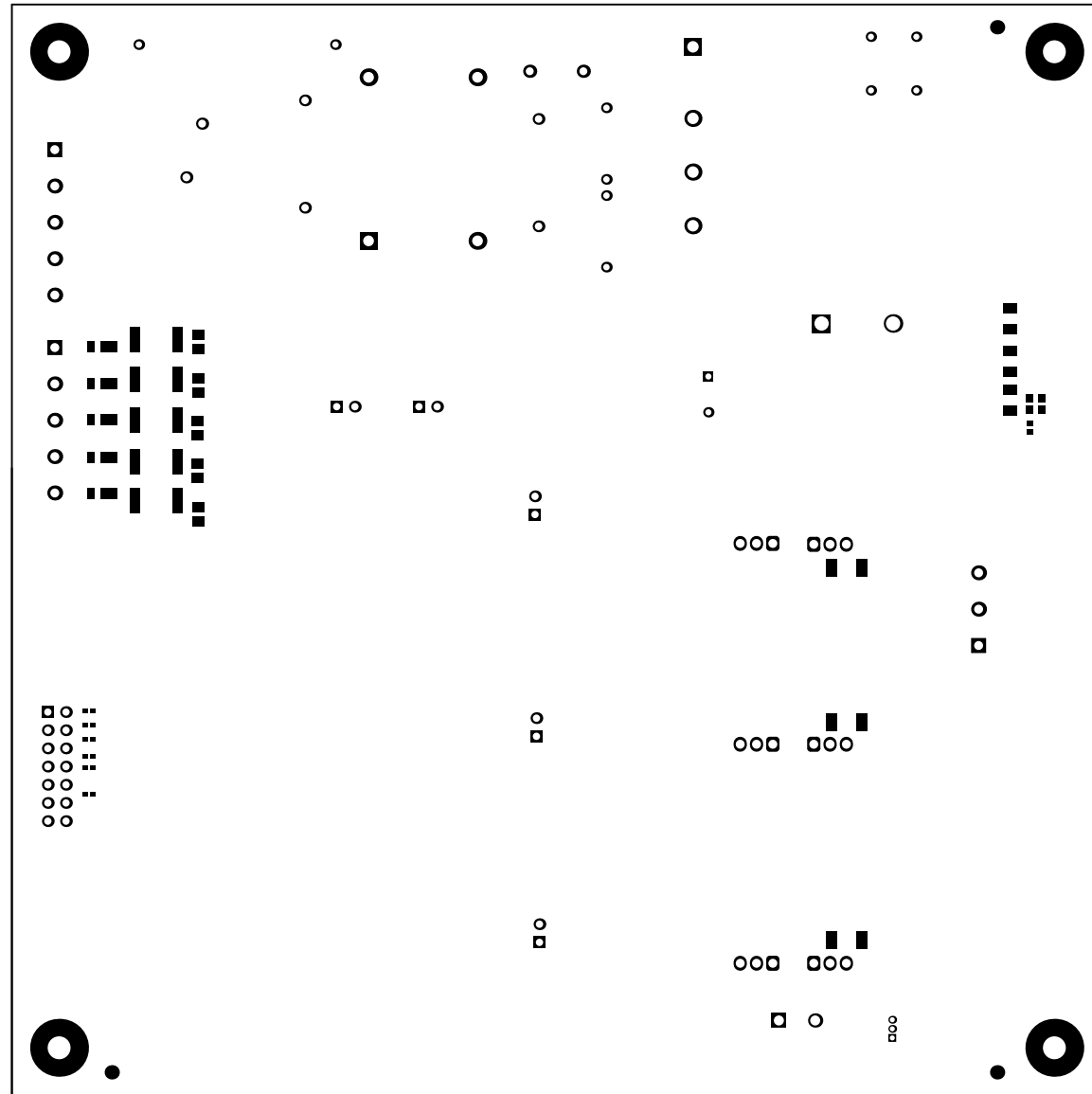
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01353	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Solder	TID #: TIDA-01353		
PLOT NAME = Top Solder Mask	GENERATED : 11/11/2016 2:58:23 PM	TEXAS INSTRUMENTS	



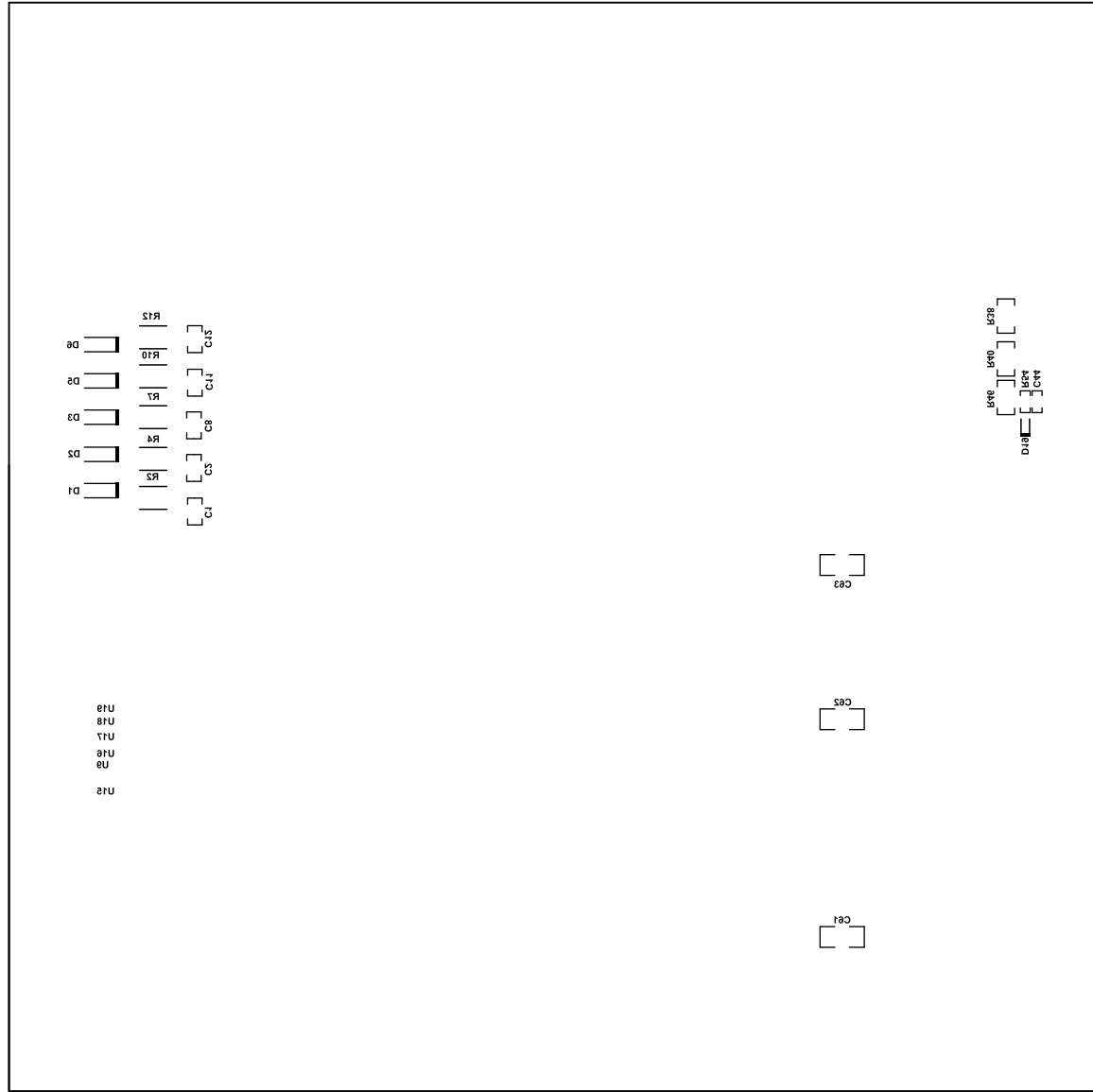
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01353	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Layer	TID #: TIDA-01353		
PLOT NAME = Top Layer	GENERATED : 11/11/2016 2:58:24 PM	TEXAS INSTRUMENTS	



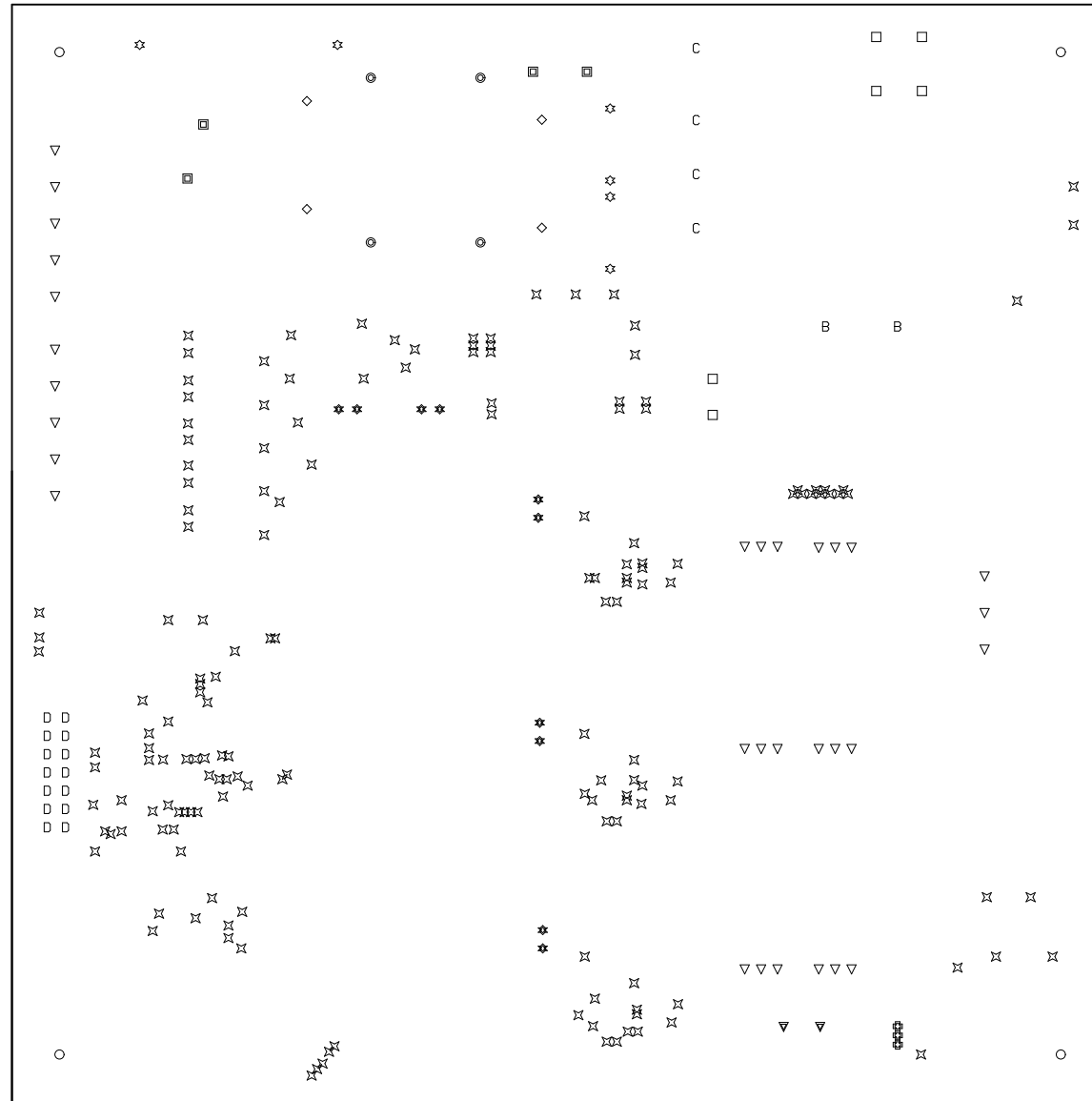
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01353	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer	TID #: TIDA-01353		
PLOT NAME = Bottom Layer	GENERATED : 11/11/2016 2:58:25 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01353	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder	TID #: TIDA-01353		
PLOT NAME = Bottom Solder Mask	GENERATED : 11/11/2016 2:58:26 PM	TEXAS INSTRUMENTS	

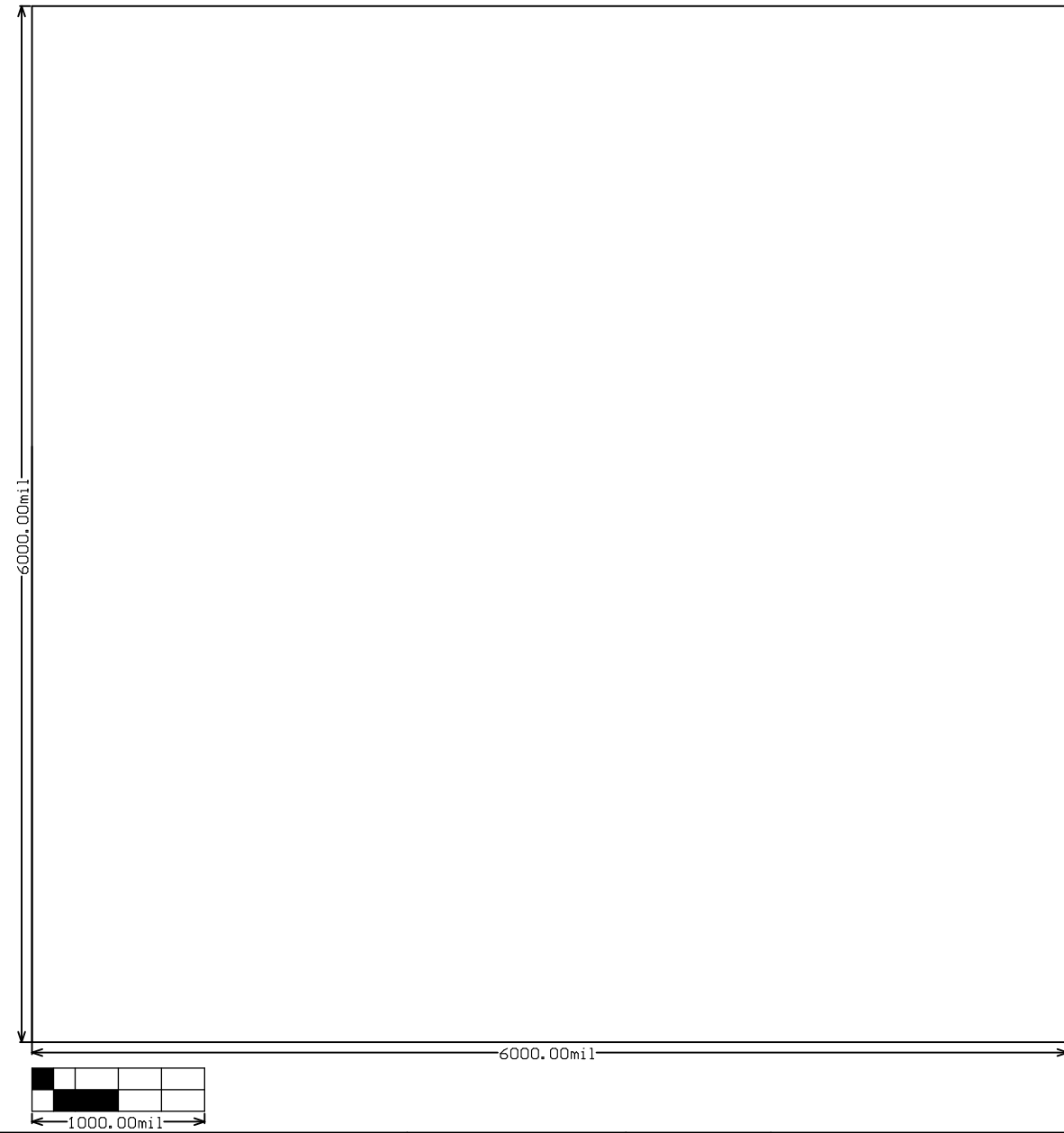


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01353	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay	TID #: TIDA-01353		
PLOT NAME = Bottom Overlay	GENERATED : 11/11/2016 2:58:27 PM	TEXAS INSTRUMENTS	



Symbol	Quantity	Finished Hole Size	Plated	Hole Type	Drill Layer Pair	Hole Tolerance
✕	165	10.00mil (0.254mm)	PTH	Round	Top Layer - Bottom Layer	
⊕	3	27.56mil (0.700mm)	PTH	Round	Top Layer - Bottom Layer	
□	6	33.46mil (0.850mm)	PTH	Round	Top Layer - Bottom Layer	
☆	6	35.43mil (0.900mm)	PTH	Round	Top Layer - Bottom Layer	
D	14	40.00mil (1.016mm)	PTH	Round	Top Layer - Bottom Layer	
★	10	40.16mil (1.020mm)	PTH	Round	Top Layer - Bottom Layer	
◇	4	41.34mil (1.050mm)	PTH	Round	Top Layer - Bottom Layer	
⊞	4	43.31mil (1.100mm)	PTH	Round	Top Layer - Bottom Layer	
▽	31	49.21mil (1.250mm)	PTH	Round	Top Layer - Bottom Layer	
▾	2	55.12mil (1.400mm)	PTH	Round	Top Layer - Bottom Layer	
◎	4	59.06mil (1.500mm)	PTH	Round	Top Layer - Bottom Layer	
C	4	62.99mil (1.600mm)	PTH	Round	Top Layer - Bottom Layer	
B	2	78.74mil (2.000mm)	PTH	Round	Top Layer - Bottom Layer	+/-3.94mil
○	4	125.98mil (3.200mm)	PTH	Round	Top Layer - Bottom Layer	
	<b>259 Total</b>					

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01353	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing	TID #: TIDA-01353		
PLOT NAME = Drill Drawing	GENERATED : 11/11/2016 2:58:27 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01353	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions	TID #: TIDA-01353		
PLOT NAME = Board Dimensions	GENERATED : 11/11/2016 2:58:29 PM	TEXAS INSTRUMENTS	



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